ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES	C. Bannockł	ourn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaration he declaration er	on of the su	bstances v all lower	within the manufactu level materials for w	rer listed	tem. Note: nanufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC 1752 Standard Form				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials an					ials and N	and Mfg Information			
Supplier Information														
Company name*	Company un	Company unique ID			Unique ID Authority				Respon	Response Date*				
onsemi										2025-06-04				
ntact Name Title - Contact			ct			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product H			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repr			epresentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	NVMYS WG	VMYS010N04CLT T6 40V LL L /G		РАК		2025-06-04		Pl	PBB		74.911	mg	Each	
Manufacturing Proccess Informati	on													
Terminal Plating / Grid Array Mate	erial Terminal Base All		Alloy	J-STD-020 MSL Rating		Peak Proce	ocess Body Temperatu		ure Max Time at Peak Tempe		ture Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260 C		С	30	seco	nds 3			
Comments														
level 1 - maximum time at peak temperatur	e during so	Idering is 10-3	0 seconds											
For more information regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	3.7	mg	Supplier	Iron (Fe)	7439-89-6		0.0044	mg
			Supplier	Copper (Cu)	7440-50-8		3.6944	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0011	mg
Die	0.5	mg	Supplier	Silicon (Si)	7440-21-3		0.5	mg
Lead Frame	33.4	mg	Supplier	Silver (Ag)	7440-22-4		0.0033	mg
			Supplier	Iron (Fe)	7439-89-6		0.0401	mg
			Supplier	Copper (Cu)	7440-50-8		33.3466	mg
			Supplier	Phosphorus (P)	7723-14-0		0.01	mg
Mold Compound-Black	31.9	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.1595	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		4.785	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.785	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0797	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		20.3363	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.7545	mg
lating	1.7	mg	Supplier	Tin (Sn)	7440-31-5		1.7	mg
Solder Paste	3.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0925	mg
			А	Lead (Pb)	7439-92-1	7a	3.4225	mg
			Supplier	Tin (Sn)	7440-31-5		0.185	mg
Wire Bond - Cu	0.011	mg	Supplier	Copper (Cu)	7440-50-8		0.011	mg